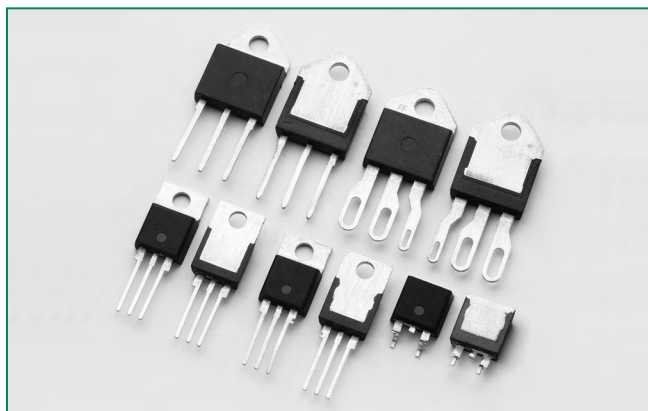


## Sxx55x Series

RoHS



### Main Features

| Symbol            | Value       | Unit |
|-------------------|-------------|------|
| $I_{T(RMS)}$      | 55          | A    |
| $V_{DRM}/V_{RRM}$ | 400 to 1000 | V    |
| $I_{GT}$          | 40          | mA   |

### Additional Information



Datasheet



Resources



Samples

### Description

Excellent unidirectional switches for phase control applications such as heating and motor speed controls.

Standard phase control SCRs are triggered with few milliamperes of current at less than 1.5V potential.

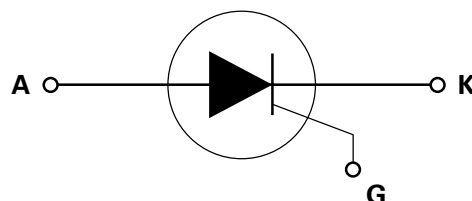
### Features & Benefits

- RoHS compliant
- Glass – passivated junctions
- Voltage capability up to 1000 V
- Surge capability up to 650 A

### Applications

Typical applications are AC solid-state switches, industrial power tools, exercise equipment, white goods and commercial appliances.

### Schematic Symbol



### Absolute Maximum Ratings

| Symbol       | Parameter                                 | Test Conditions                                                                    | Value      | Unit                   |
|--------------|-------------------------------------------|------------------------------------------------------------------------------------|------------|------------------------|
| $I_{T(RMS)}$ | RMS on-state current                      | $T_c = 90^\circ\text{C}$                                                           | 55         | A                      |
| $I_{T(AV)}$  | Average on-state current                  | $T_c = 90^\circ\text{C}$                                                           | 35.0       | A                      |
| $I_{TSM}$    | Peak non-repetitive surge current         | single half cycle; $f = 50\text{Hz}$ ;<br>$T_j(\text{initial}) = 25^\circ\text{C}$ | 550        | A                      |
|              |                                           | single half cycle; $f = 60\text{Hz}$ ;<br>$T_j(\text{initial}) = 25^\circ\text{C}$ | 650        |                        |
| $I^2t$       | $I^2t$ Value for fusing                   | $t_p = 8.3 \text{ ms}$                                                             | 1750       | $\text{A}^2\text{s}$   |
| $di/dt$      | Critical rate of rise of on-state current | $f = 60\text{Hz}$ ; $T_j = 125^\circ\text{C}$                                      | 175        | $\text{A}/\mu\text{s}$ |
| $I_{GM}$     | Peak gate current                         | $T_j = 125^\circ\text{C}$<br>$P_w = 10\mu\text{S}$                                 | 4.0        | A                      |
| $P_{G(AV)}$  | Average gate power dissipation            | $T_j = 125^\circ\text{C}$                                                          | 0.8        | W                      |
| $T_{stg}$    | Storage temperature range                 |                                                                                    | -40 to 150 | $^\circ\text{C}$       |
| $T_j$        | Operating junction temperature range      |                                                                                    | -40 to 125 | $^\circ\text{C}$       |

### Electrical Characteristics ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)

| Symbol          | Test Conditions                                                                     |       |      | Value | Unit |
|-----------------|-------------------------------------------------------------------------------------|-------|------|-------|------|
| I <sub>GT</sub> | V <sub>D</sub> = 12V; R <sub>L</sub> = 30 Ω                                         |       | MAX. | 40    | mA   |
|                 |                                                                                     |       | MIN. | 5     |      |
| V <sub>GT</sub> | V <sub>D</sub> = 12V; R <sub>L</sub> = 30 Ω                                         |       | MAX. | 1.5   | V    |
| dv/dt           | V <sub>D</sub> = V <sub>DRM</sub> ; gate open; T <sub>J</sub> = 100°C               | 400V  | MIN. | 650   | V/μs |
|                 |                                                                                     | 600V  |      | 600   |      |
|                 |                                                                                     | 800V  |      | 500   |      |
|                 |                                                                                     | 1000V |      | 250   |      |
|                 | V <sub>D</sub> = V <sub>DRM</sub> ; gate open; T <sub>J</sub> = 125°C               | 400V  |      | 550   |      |
|                 |                                                                                     | 600V  |      | 500   |      |
|                 |                                                                                     | 800V  |      | 475   |      |
|                 |                                                                                     |       |      |       |      |
| V <sub>GD</sub> | V <sub>D</sub> = V <sub>DRM</sub> ; R <sub>L</sub> = 3.3 kΩ; T <sub>J</sub> = 125°C |       | MIN. | 0.2   | V    |
| I <sub>H</sub>  | I <sub>T</sub> = 400mA (initial)                                                    |       | MAX. | 60    | mA   |
| t <sub>q</sub>  | (1)                                                                                 |       | MAX. | 35    | μs   |
| t <sub>gt</sub> | I <sub>G</sub> = 2 × I <sub>GT</sub> ; PW = 15μs; I <sub>T</sub> = 110A             |       | TYP. | 2.5   | μs   |

Note :

(1)  $I_T = 2\text{A}; t_p = 50\mu\text{s}; dv/dt = 5\text{V}/\mu\text{s}; di/dt = -30\text{A}/\mu\text{s}$

### Static Characteristics

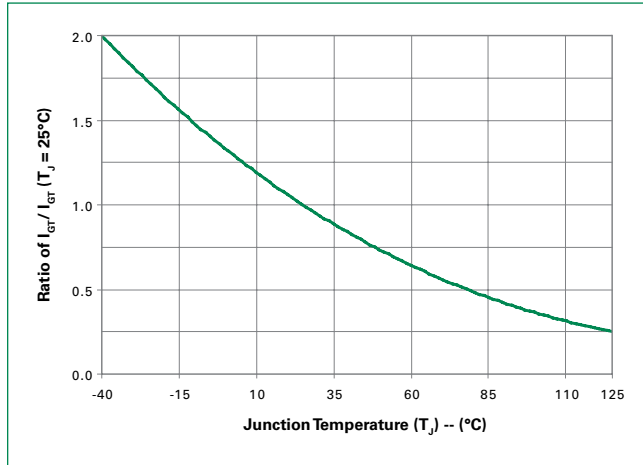
| Symbol                              | Test Conditions                               |                        |            |      | Value | Unit |
|-------------------------------------|-----------------------------------------------|------------------------|------------|------|-------|------|
| V <sub>TM</sub>                     | I <sub>T</sub> = 110A; t <sub>p</sub> = 380μs |                        |            | MAX. | 1.8   | V    |
| I <sub>DRM</sub> / I <sub>RRM</sub> | V <sub>DRM</sub> / V <sub>RRM</sub>           | T <sub>J</sub> = 25°C  | 400 – 600V | MAX. | 10    | μA   |
|                                     |                                               |                        | 800 V      |      | 20    |      |
|                                     |                                               |                        | 1000 V     |      | 30    |      |
|                                     |                                               | T <sub>J</sub> = 100°C | 400 – 600V |      | 1000  |      |
|                                     |                                               |                        | 800V       |      | 1500  |      |
|                                     |                                               |                        | 1000V      |      | 5000  |      |
|                                     |                                               | T <sub>J</sub> = 125°C | 400 – 600V |      | 2000  |      |
|                                     |                                               |                        | 800V       |      | 3000  |      |

### Thermal Resistances

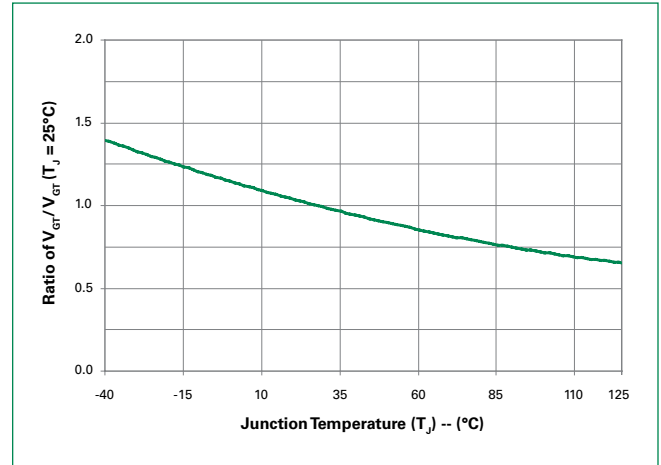
| Symbol            | Parameter             |                  | Value | Unit                      |
|-------------------|-----------------------|------------------|-------|---------------------------|
| $R_{\theta(J-C)}$ | Junction to case (AC) | Sxx55R<br>Sxx55N | 0.5   | $^\circ\text{C}/\text{W}$ |
|                   |                       | Sxx55W<br>Sxx55M | 0.53  |                           |
|                   |                       |                  |       |                           |
| $R_{\theta(J-A)}$ | Junction to ambient   | Sxx55R           | 40    | $^\circ\text{C}/\text{W}$ |

Note: xx = voltage

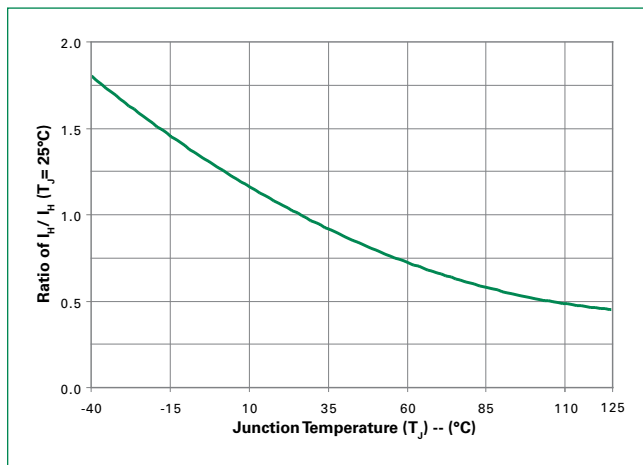
**Figure 1: Normalized DC Gate Trigger Current vs. Junction Temperature**



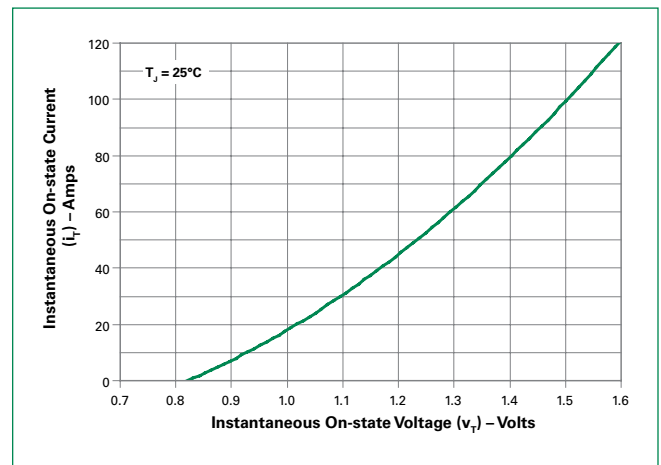
**Figure 2: Normalized DC Gate Trigger Voltage vs. Junction Temperature**



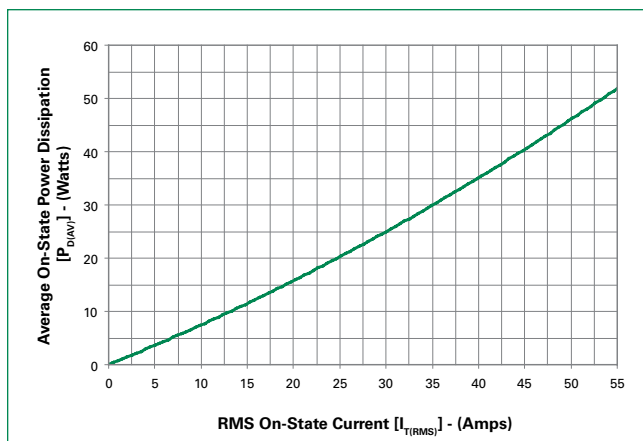
**Figure 3: Normalized DC Holding Current vs. Junction Temperature**



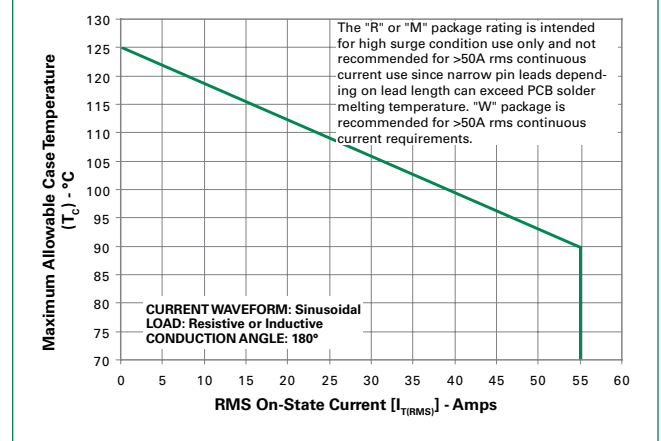
**Figure 4: On-State Current vs. On-State Voltage (Typical)**



**Figure 5: Power Dissipation (Typical) vs. RMS On-State Current**

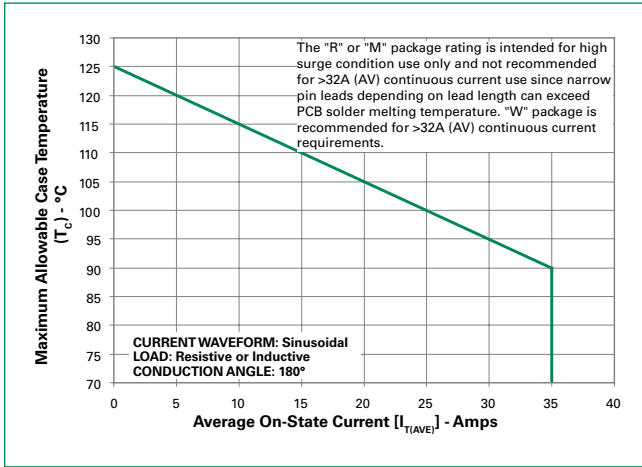


**Figure 6: Maximum Allowable Case Temperature vs. RMS On-State Current**

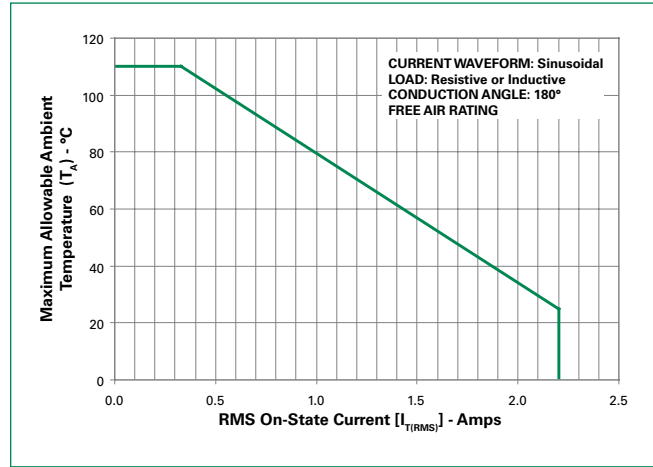


Note: xx = voltage

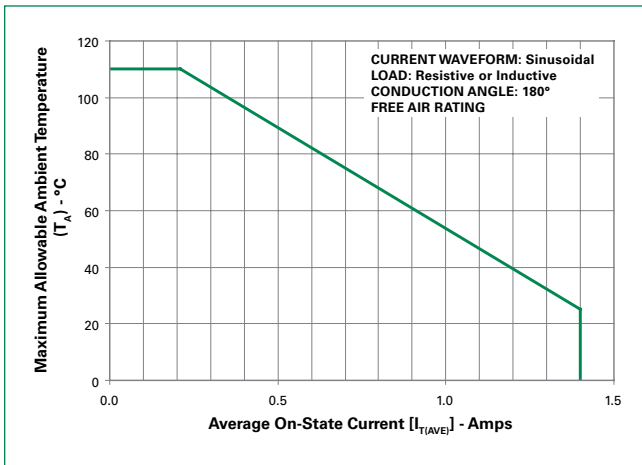
**Figure 7: Maximum Allowable Case Temperature vs. Average On-State Current**



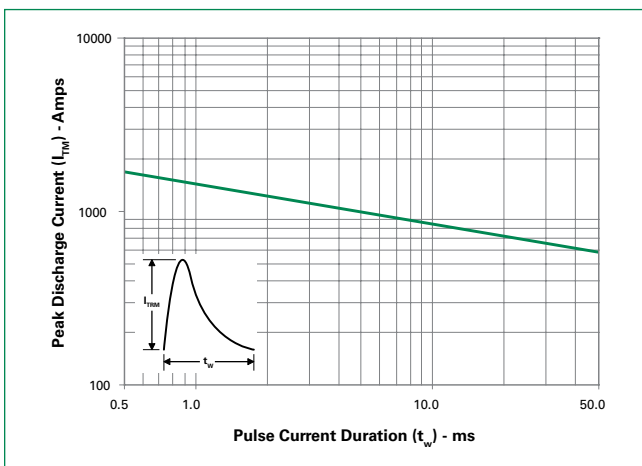
**Figure 8: Maximum Allowable Ambient Temperature vs. RMS On-State Current**



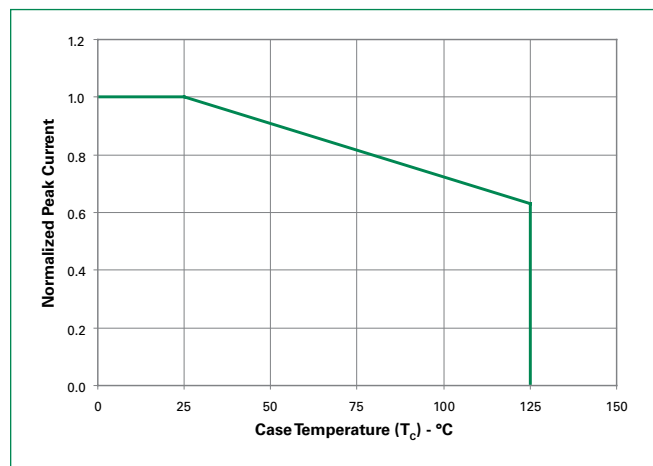
**Figure 9: Maximum Allowable Ambient Temperature vs. Average On-State Current**



**Figure 10: Peak Capacitor Discharge Current**

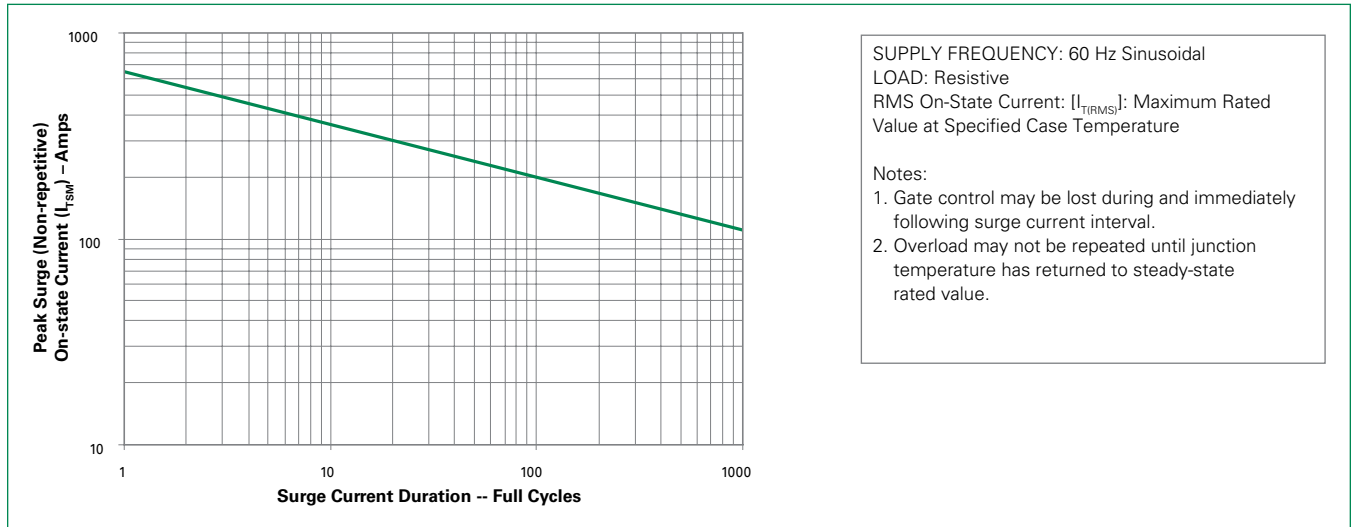


**Figure 11: Peak Capacitor Discharge Current Derating**



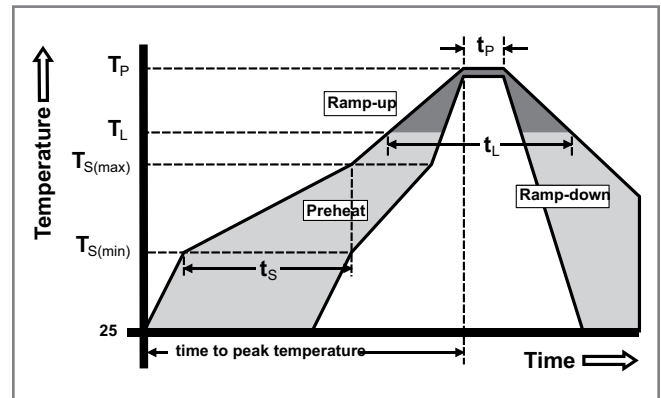
Note: xx = voltage

**Figure 12: Surge Peak On-State Current vs. Number of Cycles**



### Soldering Parameters

|                                                        |                                    |                         |
|--------------------------------------------------------|------------------------------------|-------------------------|
| Reflow Condition                                       |                                    | Pb – Free assembly      |
| Pre Heat                                               | - Temperature Min ( $T_{s(min)}$ ) | 150°C                   |
|                                                        | - Temperature Max ( $T_{s(max)}$ ) | 200°C                   |
|                                                        | - Time (min to max) ( $t_s$ )      | 60 – 180 secs           |
| Average ramp up rate (Liquidus Temp) ( $T_L$ ) to peak |                                    | 5°C/second max          |
| $T_{s(max)}$ to $T_L$ - Ramp-up Rate                   |                                    | 5°C/second max          |
| Reflow                                                 | - Temperature ( $T_L$ ) (Liquidus) | 217°C                   |
|                                                        | - Temperature ( $t_L$ )            | 60 – 150 seconds        |
| Peak Temperature ( $T_p$ )                             |                                    | 260 <sup>+0/-5</sup> °C |
| Time within 5°C of actual peak Temperature ( $t_p$ )   |                                    | 20 – 40 seconds         |
| Ramp-down Rate                                         |                                    | 5°C/second max          |
| Time 25°C to peak Temperature ( $T_p$ )                |                                    | 8 minutes Max.          |
| Do not exceed                                          |                                    | 280°C                   |



### Physical Specifications

|                        |                                                               |
|------------------------|---------------------------------------------------------------|
| <b>Terminal Finish</b> | 100% Matte Tin-plated                                         |
| <b>Body Material</b>   | UL recognized epoxy meeting flammability classification 94V-0 |
| <b>Lead Material</b>   | Copper Alloy                                                  |

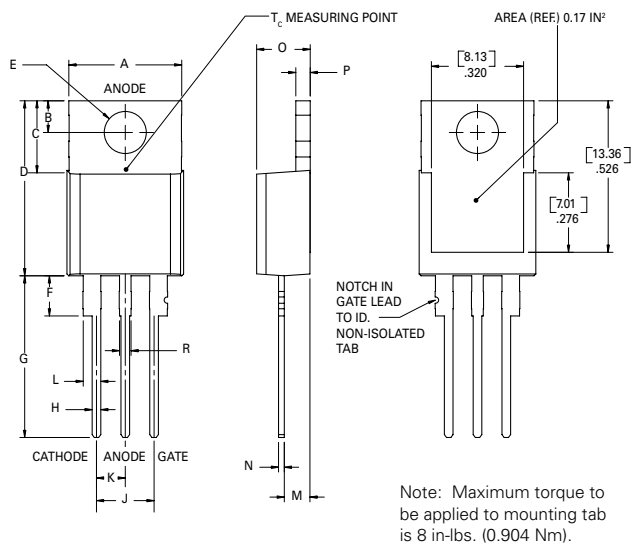
### Design Considerations

Careful selection of the correct device for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the device rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

### Environmental Specifications

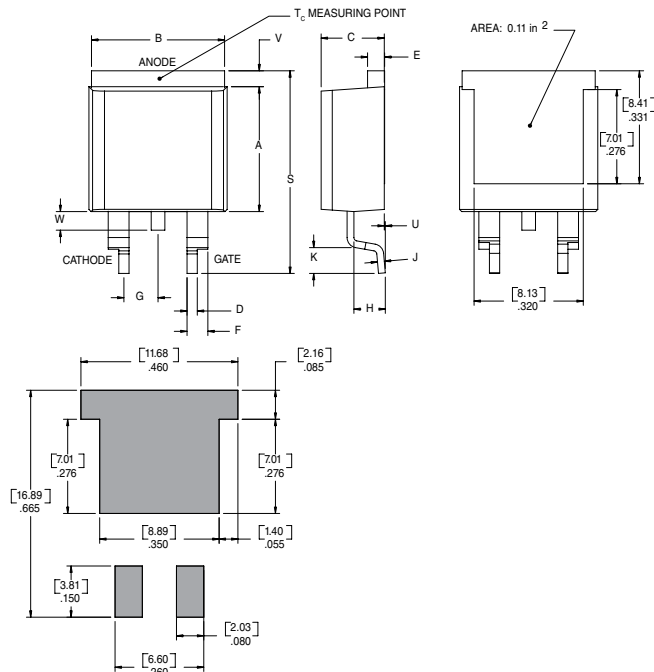
| Test                             | Specifications and Conditions                                              |
|----------------------------------|----------------------------------------------------------------------------|
| <b>AC Blocking</b>               | MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours |
| <b>Temperature Cycling</b>       | MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell-time        |
| <b>Temperature/Humidity</b>      | EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity     |
| <b>High Temp Storage</b>         | MIL-STD-750, M-1031, 1008 hours; 150°C                                     |
| <b>Low-Temp Storage</b>          | 1008 hours; -40°C                                                          |
| <b>Resistance to Solder Heat</b> | MIL-STD-750 Method 2031                                                    |
| <b>Solderability</b>             | ANSI/J-STD-002, category 3, Test A                                         |
| <b>Lead Bend</b>                 | MIL-STD-750, M-2036 Cond E                                                 |

### Dimensions — TO-220AB (R-Package) — Non-Isolated Mounting Tab Common with Center Lead



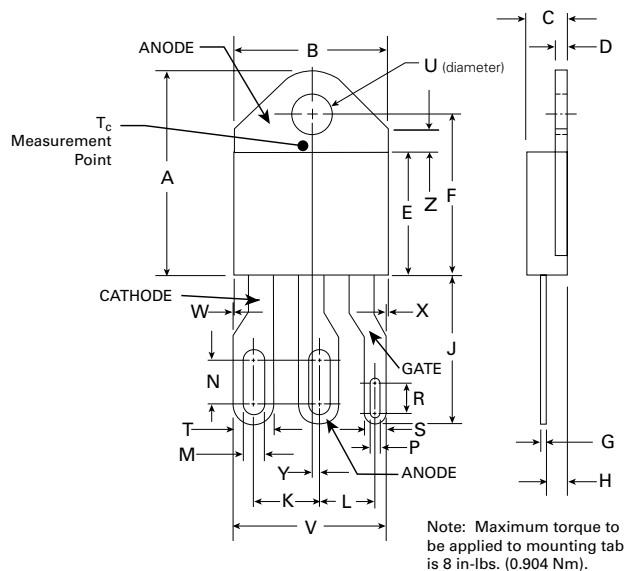
| Dimension | Inches |       | Millimeters |       |
|-----------|--------|-------|-------------|-------|
|           | Min    | Max   | Min         | Max   |
| A         | 0.380  | 0.420 | 9.65        | 10.67 |
| B         | 0.105  | 0.115 | 2.67        | 2.92  |
| C         | 0.230  | 0.250 | 5.84        | 6.35  |
| D         | 0.590  | 0.620 | 14.99       | 15.75 |
| E         | 0.142  | 0.147 | 3.61        | 3.73  |
| F         | 0.110  | 0.130 | 2.79        | 3.30  |
| G         | 0.540  | 0.575 | 13.72       | 14.61 |
| H         | 0.025  | 0.035 | 0.64        | 0.89  |
| J         | 0.195  | 0.205 | 4.95        | 5.21  |
| K         | 0.095  | 0.105 | 2.41        | 2.67  |
| L         | 0.060  | 0.075 | 1.52        | 1.91  |
| M         | 0.085  | 0.095 | 2.16        | 2.41  |
| N         | 0.018  | 0.024 | 0.46        | 0.61  |
| O         | 0.178  | 0.188 | 4.52        | 4.78  |
| P         | 0.045  | 0.060 | 1.14        | 1.52  |
| R         | 0.038  | 0.048 | 0.97        | 1.22  |

### Dimensions – TO-263AB (N-package) – D<sup>2</sup>-Pak Surface Mount



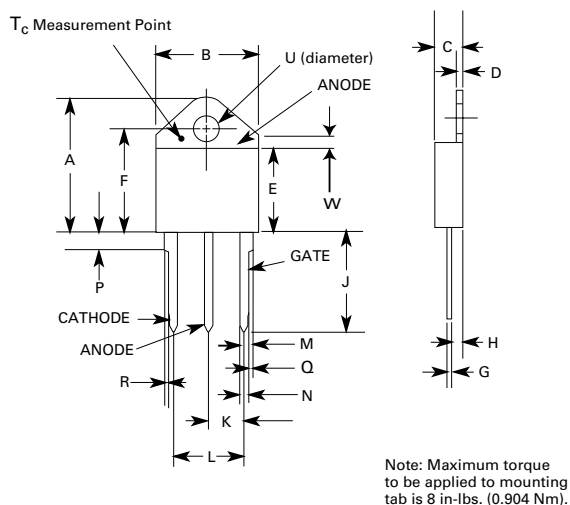
| Dimension | Inches |       | Millimeters |       |
|-----------|--------|-------|-------------|-------|
|           | Min    | Max   | Min         | Max   |
| A         | 0.360  | 0.370 | 9.14        | 9.40  |
| B         | 0.380  | 0.420 | 9.65        | 10.67 |
| C         | 0.178  | 0.188 | 4.52        | 4.78  |
| D         | 0.025  | 0.035 | 0.63        | 0.89  |
| E         | 0.048  | 0.055 | 1.22        | 1.40  |
| F         | 0.060  | 0.075 | 1.52        | 1.91  |
| G         | 0.095  | 0.105 | 2.41        | 2.67  |
| H         | 0.083  | 0.093 | 2.11        | 2.36  |
| J         | 0.018  | 0.024 | 0.46        | 0.61  |
| K         | 0.090  | 0.110 | 2.29        | 2.79  |
| S         | 0.590  | 0.625 | 14.99       | 15.87 |
| V         | 0.035  | 0.045 | 0.89        | 1.14  |
| U         | 0.002  | 0.010 | 0.05        | 0.25  |
| W         | 0.040  | 0.070 | 1.02        | 1.78  |

### Dimensions – TO-218X (W Package) – Non-Isolated Mounting Tab Common with Center Lead



| Dimension | Inches |       | Millimeters |       |
|-----------|--------|-------|-------------|-------|
|           | Min    | Max   | Min         | Max   |
| A         | 0.810  | 0.835 | 20.57       | 21.21 |
| B         | 0.610  | 0.630 | 15.49       | 16.00 |
| C         | 0.178  | 0.188 | 4.52        | 4.78  |
| D         | 0.055  | 0.070 | 1.40        | 1.78  |
| E         | 0.487  | 0.497 | 12.37       | 12.62 |
| F         | 0.635  | 0.655 | 16.13       | 16.64 |
| G         | 0.022  | 0.029 | 0.56        | 0.74  |
| H         | 0.075  | 0.095 | 1.91        | 2.41  |
| J         | 0.575  | 0.625 | 14.61       | 15.88 |
| K         | 0.256  | 0.264 | 6.50        | 6.71  |
| L         | 0.220  | 0.228 | 5.58        | 5.79  |
| M         | 0.080  | 0.088 | 2.03        | 2.24  |
| N         | 0.169  | 0.177 | 4.29        | 4.49  |
| P         | 0.034  | 0.042 | 0.86        | 1.07  |
| R         | 0.113  | 0.121 | 2.87        | 3.07  |
| S         | 0.086  | 0.096 | 2.18        | 2.44  |
| T         | 0.156  | 0.166 | 3.96        | 4.22  |
| U         | 0.164  | 0.165 | 4.10        | 4.20  |
| V         | 0.603  | 0.618 | 15.31       | 15.70 |
| W         | 0.000  | 0.005 | 0.00        | 0.13  |
| X         | 0.003  | 0.012 | 0.07        | 0.30  |
| Y         | 0.028  | 0.032 | 0.71        | 0.81  |
| Z         | 0.085  | 0.095 | 2.17        | 2.42  |

**Dimensions – TO-218AC (M Package) – Non-isolated Mounting Tab Common with Center Lead**



| Dimension | Inches |       | Millimeters |       |
|-----------|--------|-------|-------------|-------|
|           | Min    | Max   | Min         | Max   |
| A         | 0.810  | 0.835 | 20.57       | 21.21 |
| B         | 0.610  | 0.630 | 15.49       | 16.00 |
| C         | 0.178  | 0.188 | 4.52        | 4.78  |
| D         | 0.055  | 0.070 | 1.40        | 1.78  |
| E         | 0.487  | 0.497 | 12.37       | 12.62 |
| F         | 0.635  | 0.655 | 16.13       | 16.64 |
| G         | 0.022  | 0.029 | 0.56        | 0.74  |
| H         | 0.075  | 0.095 | 1.91        | 2.41  |
| J         | 0.575  | 0.625 | 14.61       | 15.88 |
| K         | 0.211  | 0.219 | 5.36        | 5.56  |
| L         | 0.422  | 0.437 | 10.72       | 11.10 |
| M         | 0.058  | 0.068 | 1.47        | 1.73  |
| N         | 0.045  | 0.055 | 1.14        | 1.40  |
| P         | 0.095  | 0.115 | 2.41        | 2.92  |
| Q         | 0.008  | 0.016 | 0.20        | 0.41  |
| R         | 0.008  | 0.016 | 0.20        | 0.41  |
| U         | 0.164  | 0.165 | 4.10        | 4.20  |
| W         | 0.085  | 0.095 | 2.17        | 2.42  |

**Product Selector**

| Part Number | Voltage |      |      |       | Gate Sensitivity | Type         | Package  |
|-------------|---------|------|------|-------|------------------|--------------|----------|
|             | 400V    | 600V | 800V | 1000V |                  |              |          |
| Sxx55R      | X       | X    | X    | X     | 40mA             | Standard SCR | TO-220R  |
| Sxx55N      | X       | X    | X    | X     | 40mA             | Standard SCR | TO-263   |
| Sxx55W      | X       | X    | X    |       | 40mA             | Standard SCR | TO-218X  |
| Sxx55M      | X       | X    | X    | X     | 40mA             | Standard SCR | TO-218AC |

Note: xx = Voltage

**Packing Options**

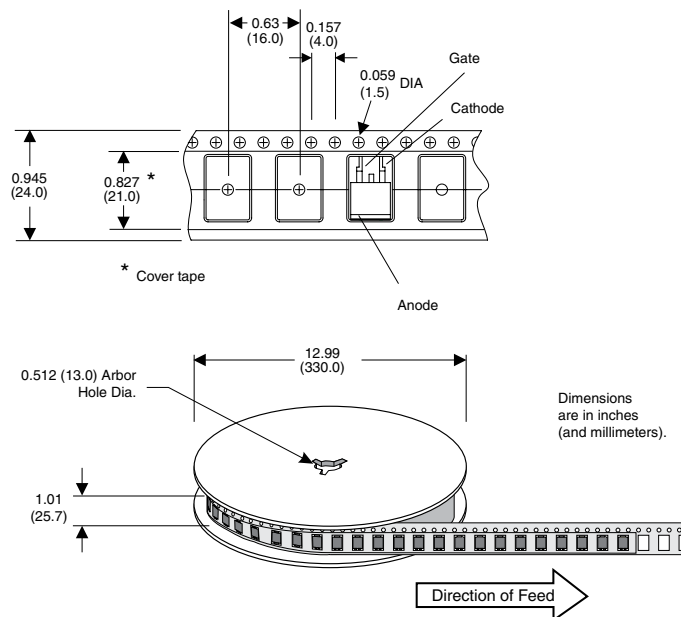
| Part Number | Marking | Weight | Packing Mode     | Base Quantity     |
|-------------|---------|--------|------------------|-------------------|
| Sxx55RTP    | Sxx55R  | 2.2g   | Tube             | 500 (50 per tube) |
| Sxx55NTP    | Sxx55N  | 1.6g   | Tube             | 500 (50 per tube) |
| Sxx55NRP    | Sxx55N  | 1.6g   | Embossed Carrier | 500               |
| Sxx55WTP    | Sxx55W  | 5.23g  | Tube             | 250 (25 per tube) |
| Sxx55MTP    | Sxx55M  | 4.40g  | Tube             | 250 (25 per tube) |

Note: xx = Voltage

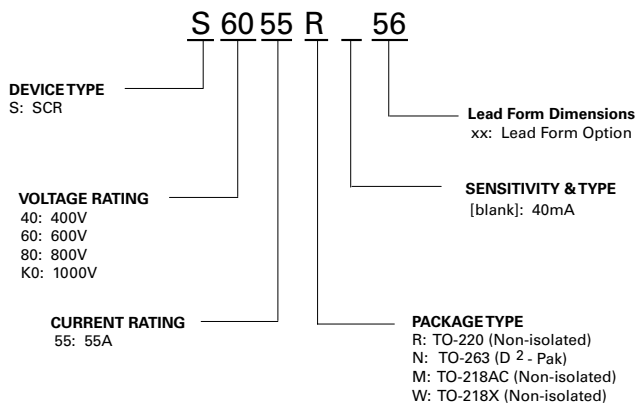


## TO-263 Embossed Carrier Reel Pack (RP) Specification

Meets all EIA-481-2 Standards



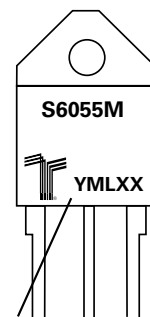
## Part Numbering System



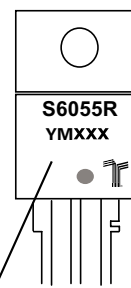
## Part Marking System

TO-218AC - (M Package)  
TO-218X - (W Package)

TO-220 AB - (R Package)  
TO-263 AB - (N Package)



**Date Code Marking**  
Y: Year Code  
M: Month Code  
L: Location Code  
XX: Lot Serial Code



**Date Code Marking**  
Y: Year Code  
M: Month Code  
XXX: Lot Trace Code

## Данный компонент на территории Российской Федерации

**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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